

FAIRCHILD
SEMICONDUCTOR™

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FSUSB11

Low Power High Bandwidth USB Switch

Dual SPDT Multiplexer/Demultiplexer

General Description

The FSUSB11 is a high performance Dual Single Pole Double Throw (SPDT) analog switch specially designed for the switching of both analog audio signal and USB 1.1 signals. The device features ultra low R_{ON} of 1.3 Ω maximum at 4.5V V_{CC} and 4.3 Ω at 2.7V supply. High bandwidth and ultra low ON Resistance (R_{ON}) make this switch to be able to pass both USB low and full speed signal with minimum signal distortion. The device is fabricated with sub-micron CMOS technology to achieve fast switching speeds and is designed for break-before-make operation. The select input is TTL level compatible.

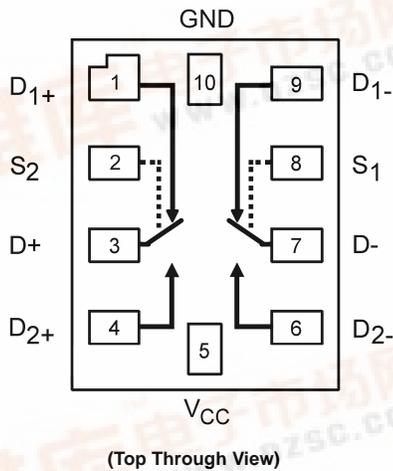
Features

- Space saving MicroPak™ packaging (1.6mm x 2.1mm)
- USB 1.1 signal switching compliant
- -3db bandwidth: >350MHz
- Maximum 1.15 Ω ON Resistance at 4.5V V_{CC} and 4 Ω for 2.7V supply
- 0.3 Ω maximum R_{ON} flatness for +5V supply
- Broad V_{CC} operating range: 1.65V to 5.5V
- Fast turn-on and turn-off time
- Break-before-make enable circuitry
- Over-voltage tolerant TTL compatible control input

Ordering Code:

Order Number	Package Number	Product Code Top Mark	Package Description	Supplied As
FSUSB11L10X	MAC010A	ET	10-Lead MicroPak, 1.6 mm x 2.1mm	5K Units on Tape and Reel

Analog Symbols



Truth Table

Control Input(s)	Function
L	D ₁ Connected to D+/D-
H	D ₂ Connected to D+/D-

H = HIGH Logic Level
L = LOW Logic Level

Pin Descriptions

Pin Names	Function
D, D ₁ , D ₂	Data Ports
S	Control Input

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FSUSB11 Low Power High Bandwidth USB Switch Dual SPDT Multiplexer/Demultiplexer



Absolute Maximum Ratings (Note 1)		Recommended Operating Conditions	
Supply Voltage (V_{CC})	-0.5V to +6.0V	Supply Voltage (V_{CC})	1.65V to 5.5V
Switch Voltage (V_S) (Note 2)	-0.5V to $V_{CC} + 0.5V$	Control Input Voltage (V_{IN}) (Note 3)	0V to V_{CC}
Input Voltage (V_{IN}) (Note 2)	-0.5V to +6.0V	Switch Input Voltage (V_{IN})	0V to V_{CC}
Input Diode Current	-50 mA	Operating Temperature (T_A)	-40°C to +85°C
Switch Current	200 mA		
Peak Switch Current (Pulsed at 1 ms duration, <10% Duty Cycle)	400 mA		
Storage Temperature Range (T_{STG})	-65°C to +150°C		
Maximum Junction Temperature (T_J)	+150°C		
Lead Temperature (T_L)			
Soldering, 10 seconds	+260°C		
ESD			
Human Body Model	8000V		

Note 1: The "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the absolute maximum ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

Note 2: The input and output negative voltage ratings may be exceeded if the input and output diode current ratings are observed.

Note 3: Unused inputs must be held HIGH or LOW. They may not float.

DC Electrical Characteristics (All typical values are @ 25°C unless otherwise specified)

Symbol	Parameter	V_{CC} (V)	$T_A = +25^\circ\text{C}$			$T_A = -40^\circ\text{C to } +85^\circ\text{C}$		Units	Conditions
			Min	Typ	Max	Min	Max		
V_{IH}	Input Voltage High	2.7 to 3.6				2.0	V		
		4.5 to 5.5				2.4			
V_{IL}	Input Voltage Low	2.7 to 3.6					0.6	V	
		4.5 to 5.5					0.8		
I_{IN}	Control Input Leakage	2.7 to 3.6				-1.0	1.0	μA	$V_{IN} = 0V \text{ to } V_{CC}$
		4.5 to 5.5				-1.0	1.0		
$I_{NO(OFF)}$	OFF-Leakage Current of Port D ₁ and D ₂	5.5	-50.0	50.0	-100	100	nA	A = 1V, 4.5V B ₀ or B ₁ = 1V, 4.5V	
$I_{A(ON)}$	ON Leakage Current of Port D	5.5	-50.0	50.0	-100	100	nA	A = 1V, 4.5V B ₀ or B ₁ = 1V, 4.5V or Floating	
R_{ON}	Switch ON Resistance (Note 4)	2.7	2.6	4.0		4.3	Ω	$I_{OUT} = 100 \text{ mA}, D_1 \text{ or } D_2 = 1.5V$	
		4.5	0.95	1.15		1.3		$I_{OUT} = 100 \text{ mA}, D_1 \text{ or } D_2 = 3.5V$	
ΔR_{ON}	ON Resistance Matching Between Channels (Note 5)	2.7				0.15	Ω	$I_{OUT} = 100 \text{ mA}, D_1 \text{ or } D_2 = 1.5V$	
		4.5	0.06	0.12				$I_{OUT} = 100 \text{ mA}, D_1 \text{ or } D_2 = 3.5V$	
$R_{FLAT(ON)}$	ON Resistance Flatness (Note 6)	2.7	1.4				Ω	$I_{OUT} = 100 \text{ mA}, D_1 \text{ or } D_2 = 0V, 0.75V, 1.5V$	
		4.5	0.2	0.3		0.4		$I_{OUT} = 100 \text{ mA}, B_0 \text{ or } B_1 = 0V, 1V, 2V$	
I_{CC}	Quiescent Supply Current	3.6	0.1	0.5		1.0	μA	$V_{IN} = 0V \text{ or } V_{CC}, I_{OUT} = 0V$	
		5.5	0.1	0.5		1.0			

Note 4: ON Resistance is determined by the voltage drop between D and D_n pins at the indicated current through the switch.

Note 5: $\Delta R_{ON} = R_{ONmax} - R_{ONmin}$ measured at identical V_{CC} , temperature, and voltage.

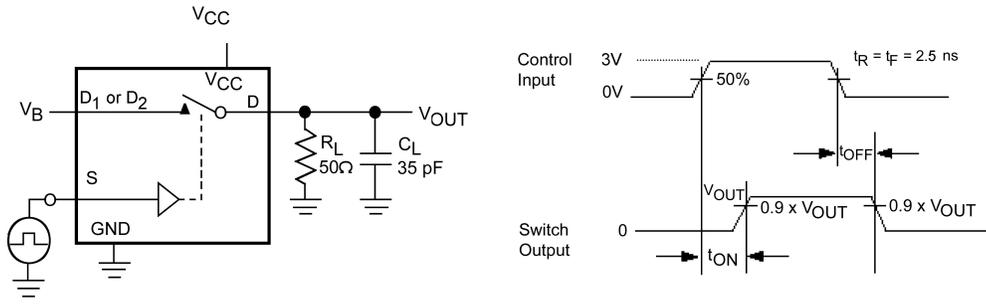
Note 6: Flatness is defined as the difference between the maximum and minimum value of ON Resistance over the specified range of conditions.

AC Electrical Characteristics (All typical value are @ 25°C unless otherwise specified)										
Symbol	Parameter	V _{CC} (V)	T _A = +25°C			T _A = -40°C to +85°C		Units	Conditions	Figure Number
			Min	Typ	Max	Min	Max			
t _{ON}	Turn ON Time	2.7 to 3.6	50.0			60.0		ns	D ₁ or D ₂ = 1.5V, R _L = 50Ω, C _L = 35 pF D ₁ or D ₂ = 3.0V, R _L = 50Ω, C _L = 35 pF	Figure 1
		4.5 to 5.5	35.0			40.0				
t _{OFF}	Turn OFF Time	2.7 to 3.6	20.0			30.0		ns	D ₁ or D ₂ = 1.5V, R _L = 50Ω, C _L = 35 pF D ₁ or D ₂ = 3.0V, R _L = 50Ω, C _L = 35 pF	Figure 1
		4.5 to 5.5	15.0			20.0				
t _{B-M}	Break-Before-Make Time	2.7 to 3.6	1.0			1.0		ns	D ₁ or D ₂ = 1.5V, R _L = 50Ω, C _L = 35 pF D ₁ or D ₂ = 3.0V, R _L = 50Ω, C _L = 35 pF	Figure 2
		4.5 to 5.5	20.0			1.0				
Q	Charge Injection	2.7 to 3.6	20.0					pC	C _L = 1.0 nF, V _{GEN} = 0V, R _{GEN} = 0Ω	Figure 4
		4.5 to 5.5	10.0							
OIRR	OFF-Isolation	2.7 to 3.6	-70.0					dB	f = 1MHz, R _L = 50Ω	Figure 3
		4.5 to 5.5	-70.0							
Xtalk	Crosstalk	2.7 to 3.6	-75.0					dB	f = 1MHz, R _L = 50Ω	Figure 3
		4.5 to 5.5	-75.0							
BW	-3db Bandwidth	2.7 to 3.6	350					MHz	R _L = 50Ω	Figure 6
		4.5 to 5.5	350							

USB Related AC Electrical Characteristics (All typical value are @25°C unless otherwise specified)								
Symbol	Parameter	V _{CC} (V)	T _A = +25°C			Units	Conditions	Figure Number
			Min	Typ	Max			
t _{SKEW}	Skew	2.7 to 3.6	0.15			ns	R _S = 39Ω, C _L = 50 pF t _R = t _F = 12ns at 12Mbps (Duty Cycle = 50%)	Figure 7
		4.5 to 5.5	0.15					
t _M	Rising/Fall Time Mismatch	2.7 to 3.6	10.0			%	(Duty Cycle = 50%)	Figure 7
		4.5 to 5.5	10.0					
t _J	Total Jitter	2.7 to 3.6	1.7			ns	R _S = 39Ω, C _L = 50 pF, t _R = t _F = 12 ns at 12Mbps (PRBS = 2 ¹⁵ - 1)	Figure 7
		4.5 to 5.5	1.6					

Capacitance							
Symbol	Parameter	V _{CC} (V)	T _A = +25°C			Units	Conditions
			Min	Typ	Max		
C _{IN}	Control Pin Input Capacitance	0.0	3.5			pF	f = 1MHz (see Figure 5)
C _{OFF}	D _n Port OFF Capacitance	4.5	12.0			pF	f = 1MHz (see Figure 5)
C _{ON}	D Port ON Capacitance	4.5	55.0			pF	f = 1MHz (see Figure 5)

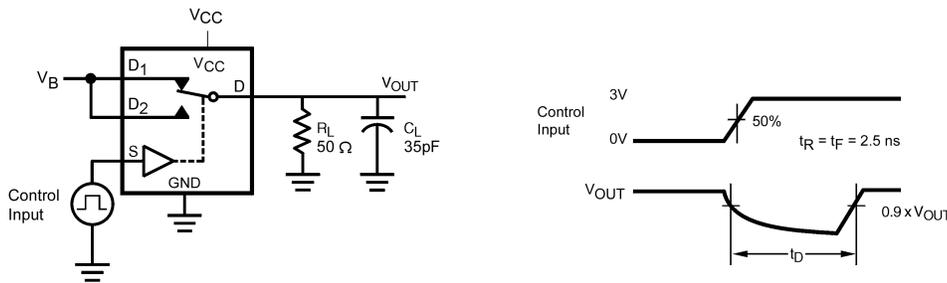
AC Loading and Waveforms



C_L includes Fixture and Stray Capacitance

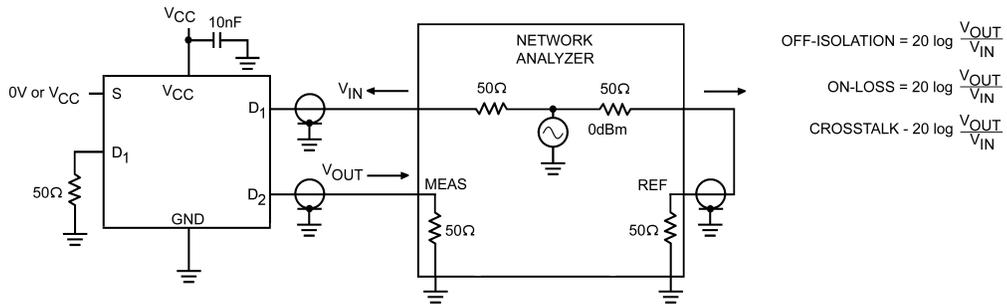
Logic Input Waveforms Inverted for Switches that have the Opposite Logic Sense

FIGURE 1. Turn-On/Turn-Off Timing



C_L Includes Fixture and Stray Capacitance

FIGURE 2. Break-Before-Make Timing



$$\begin{aligned} \text{OFF-ISOLATION} &= 20 \log \frac{V_{\text{OUT}}}{V_{\text{IN}}} \\ \text{ON-LOSS} &= 20 \log \frac{V_{\text{OUT}}}{V_{\text{IN}}} \\ \text{CROSSTALK} &= 20 \log \frac{V_{\text{OUT}}}{V_{\text{IN}}} \end{aligned}$$

FIGURE 3. OFF Isolation and Crosstalk

AC Loading and Waveforms (Continued)

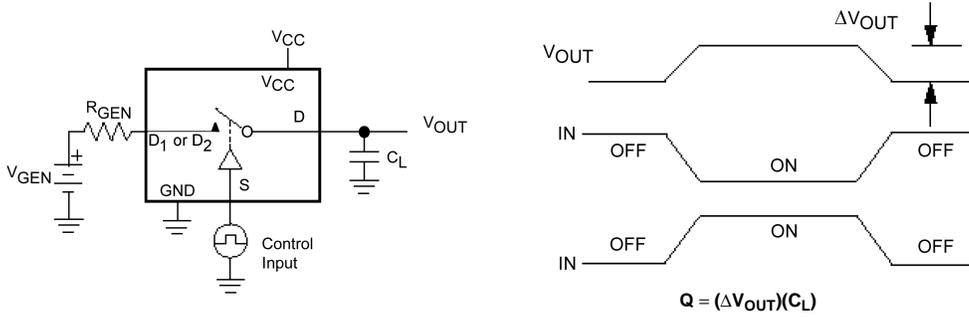


FIGURE 4. Charge Injection

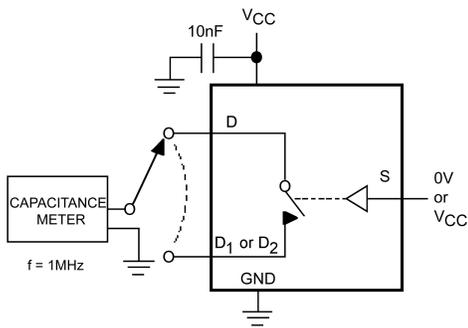


FIGURE 5. ON/OFF Capacitance Measurement Setup

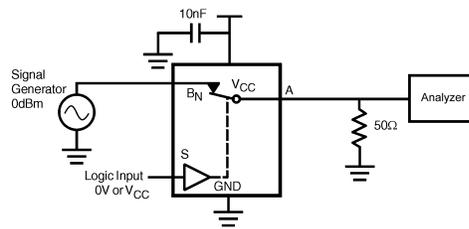


FIGURE 6. Bandwidth

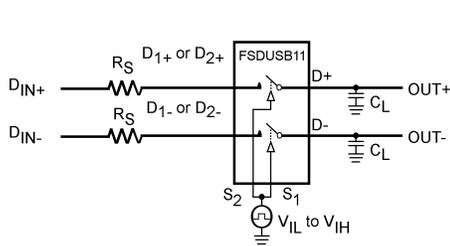


FIGURE 7. Skew Test

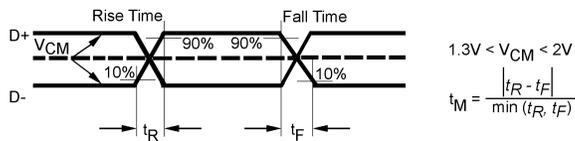
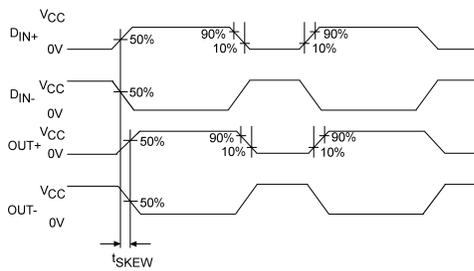
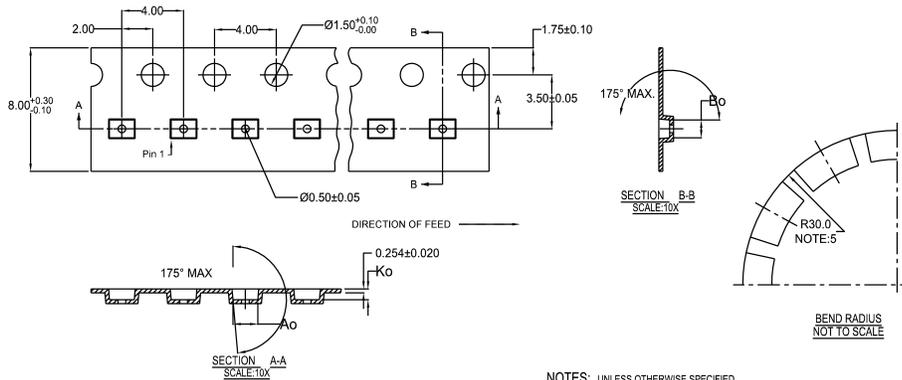


FIGURE 8. Rise/Fall Time Mismatch Test

Tape and Reel Specification

Tape Format For Micropak 10

Package Designator	Tape Section	Number Cavities	Cavity Status	Cover Tape Status
L10X	Leader (Start End)	125 (typ)	Empty	Sealed
	Carrier	5000	Filled	Sealed
	Trailer (Hub End)	75 (typ)	Empty	Sealed



10	300056	2.30±0.05	1.78±0.05	0.68±0.05
8	300038	1.78±0.05	1.78±0.05	0.68±0.05
6	300033	1.60±0.05	1.15±0.05	0.70±0.05

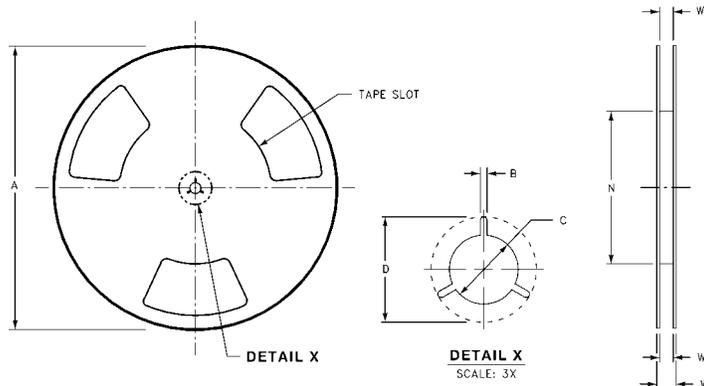


SCALE: 6X

NOTES: UNLESS OTHERWISE SPECIFIED

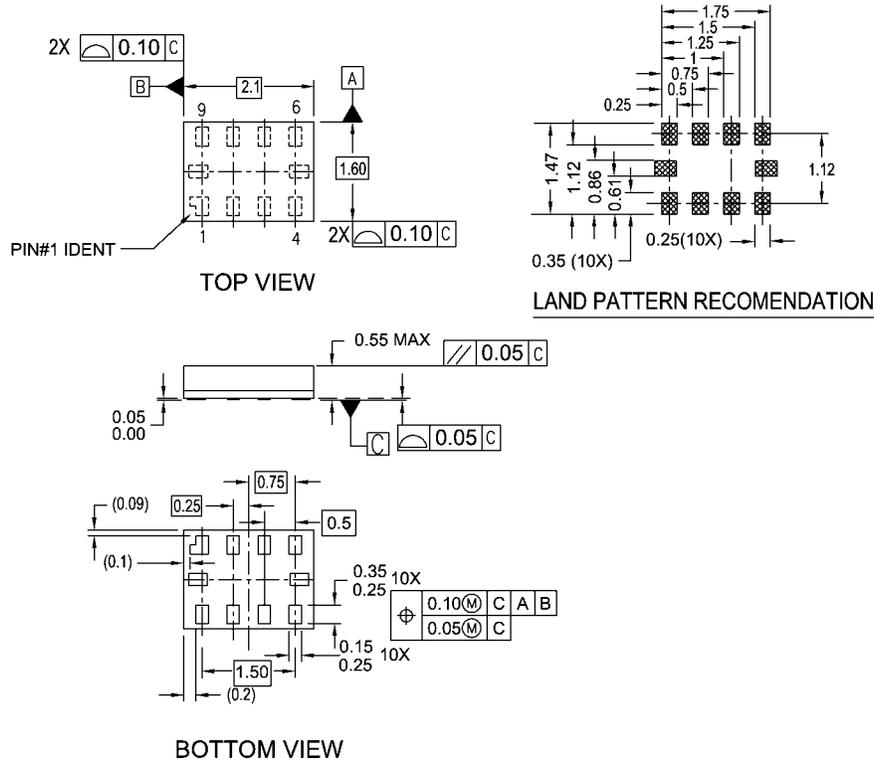
1. ACCUMULATED 50 SPROCKETS, SPROCKET HOLE PITCH IS 200.00 ± 0.30MM
2. NO INDICATED CORNER RADIUS IS 0.127MM
3. CAMBER NOT TO EXCEED 1MM IN 100MM
4. SMALLEST ALLOWABLE BENDING RADIUS
5. POCKET POSITION RELATIVE TO SPROCKET HOLE MEASURED AS TRUE POSITION OF POCKET, NOT POCKET HOLE

REEL DIMENSIONS inches (millimeters)



Tape Size	A	B	C	D	N	W1	W2	W3
8 mm	7.0 (177.8)	0.059 (1.50)	0.512 (13.00)	0.795 (20.20)	2.165 (55.00)	0.331 + 0.059/-0.000 (8.40 + 1.50/-0.00)	0.567 (14.40)	W1 + 0.078/-0.039 (W1 + 2.00/-1.00)

Physical Dimensions inches (millimeters) unless otherwise noted



NOTES:

- A. PACKAGE CONFORMS TO JEDEC MO255, VARIATION UABD
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCES CONFORMS TO ASME Y14.5M, 1994.

MAC010ARevB

**10-Lead MicroPak, 1.6 mm x 2.1mm
Package Number MAC010A**

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2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

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